



NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE15P25JK uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

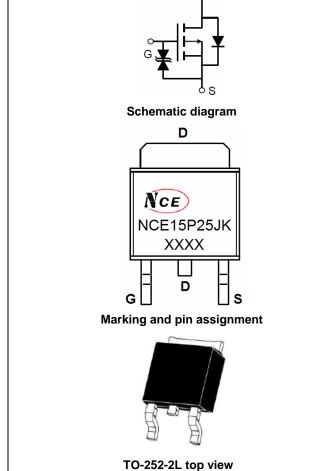
- V_{DS} =-150V, I_D =-25A $R_{DS(ON)}$ <135m Ω @ V_{GS} =-10V (Typ.=120mR) $R_{DS(ON)}$ <160m Ω @ V_{GS} =-4.5V (Typ.=131mR)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

• Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE15P25JK	NCE15P25JK	TO-252-2L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	-150	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	I _D	-25	А	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-17	А	
Pulsed Drain Current	I _{DM}	-140	А	
Maximum Power Dissipation	PD	160	W	
Derating factor		1.3	W/℃	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C	



Pb Free Product



Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	0.8	°C/W
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Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	· · ·						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-145	-155	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-145V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±10	μA	
On Characteristics (Note 3)	· · ·						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, I _D =-250µA	-1.5	-1.9	-3	V	
Durain Course On Chata Desintance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	120	135	mΩ	
Drain-Source On-State Resistance		V _{GS} =-4.5V, I _D =-20A	-	131	160		
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-20A	5	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	7650	-	PF	
Output Capacitance	C _{oss}	V_{DS} =-75V, V_{GS} =0V,	-	148	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	131	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	17	-	nS	
Turn-on Rise Time	tr	V _{DD} =-75V,I _D =-20A	-	80	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =9.1 Ω	-	45	-	nS	
Turn-Off Fall Time	t _f		-	65	-	nS	
Total Gate Charge	Qg		-	137	-	nC	
Gate-Source Charge	Q _{gs}	V_{DS} =-75V,I _D =-20A,	-	25	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	28	-	nC	
Drain-Source Diode Characteristics						•	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-25A	-	-	-1.2	V	
Diode Forward Current (Note 2)	I _S	-	-	-	-25	А	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-25A	-	90	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	105	-	nC	
			4				

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ \!\! \mathbb{C}, V_{DD} \!\! = \!\! -75V, V_G \!\! = \!\! -10V, L \!\! = \!\! 0.5mH, Rg \!\! = \!\! 25\Omega$

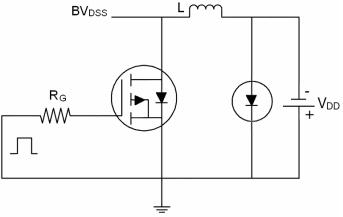


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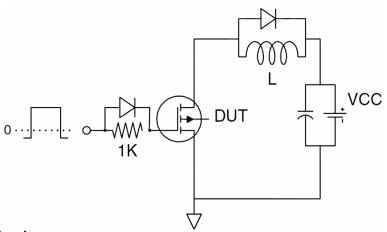
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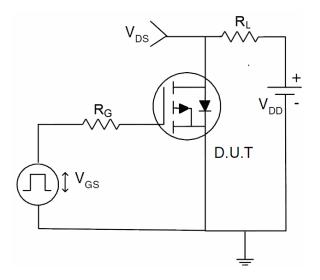
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



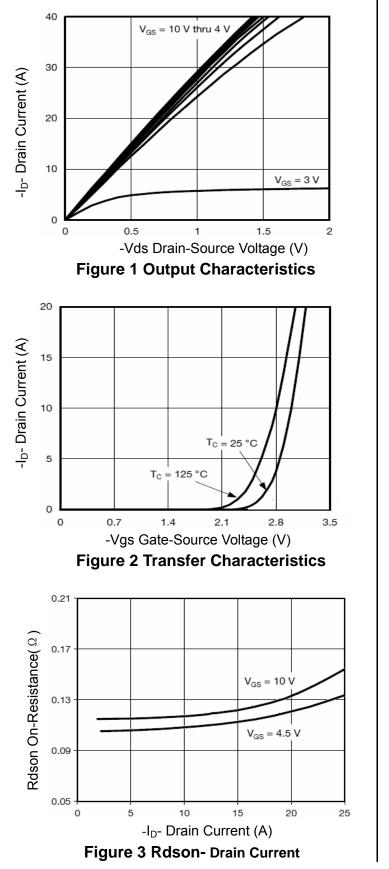
3) Switch Time Test Circuit

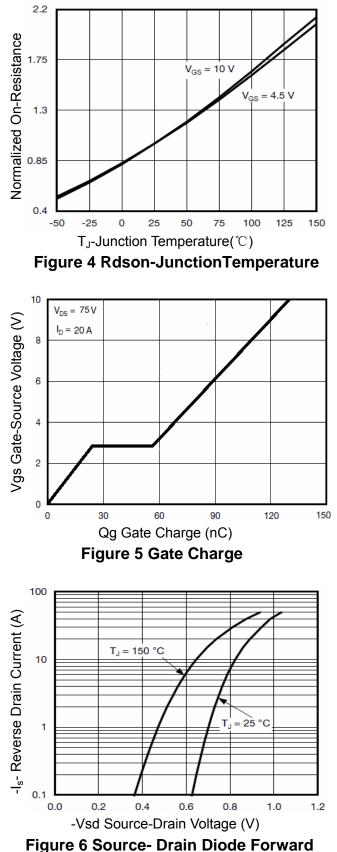






Typical Electrical and Thermal Characteristics (Curves)

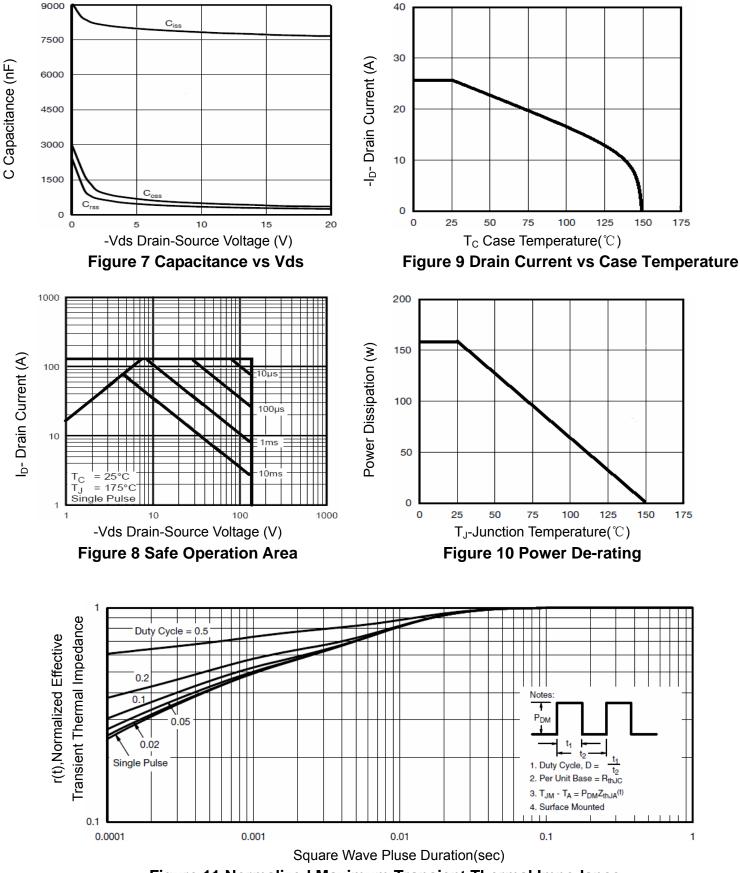






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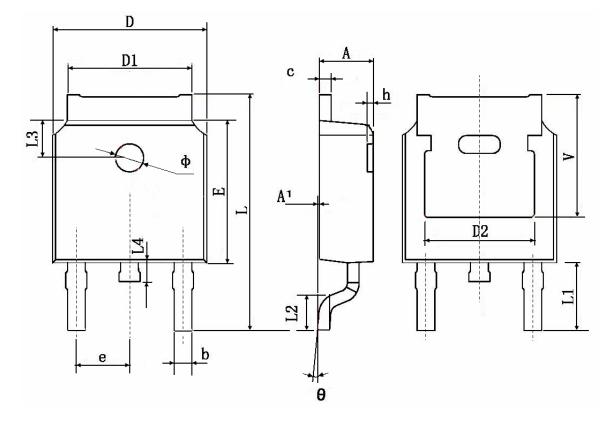




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TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
e	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.90	0 TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.60	00 TYP. 0.063 TYP.		B TYP.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	0 TYP.	0.211 TYP.		







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